

DMTH6010LPSW

60V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

| BV _{DSS} | Rds(on) | I _D Tc = +25°С |
|-------------------|-------------------------------|------------------------------|
| 60V | 8mΩ @ V _{GS} = 10V | 80A |
| 000 | 12mΩ @ V _{GS} = 4.5V | 64.5A |

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Engine management systems
- Body control electronics
- DC-DC converters

Features

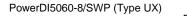
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Low RDS(ON) Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 - https://www.diodes.com/guality/product-definitions/
- An automotive-compliant part is available under separate datasheet (<u>DMTH6010LPSWQ</u>)

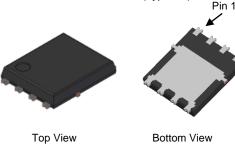
Mechanical Data

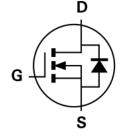
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (63)
- Weight: 0.097 grams (Approximate)

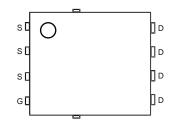


PowerDI5060-8 (SWP) (Type Q)









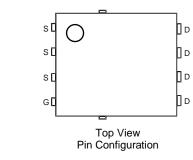
Internal Schematic

D

S

Internal Schematic

Top View Pin Configuration



Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

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3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Ordering Information (Note 4)

| Orderable Part Number | Baakaga | Pa | cking |
|-----------------------|------------------------------|-------|-------------|
| | Package | Qty. | Carrier |
| DMTH6010LPSW-13 | PowerDI5060-8 (SWP) (Type Q) | 2,500 | Tape & Reel |
| DMTH6010LPSW-13 | PowerDI5060-8/SWP (Type UX) | 2,500 | Tape & Reel |

Note: 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|---|---|------------------|------------|----|
| Drain-Source Voltage | | V _{DSS} | 60 | V |
| Gate-Source Voltage | | Vgss | ±20 | V |
| Continuous Drain Current, V _{GS} = 10V (Note 5) | T _A = +25°C T _A = +100°C | lD | 15.5 11 | A |
| Continuous Drain Current, V _{GS} = 10V (Note 6) $T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$ | | lр | 80 56 | А |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | Ідм | 320 | А | |
| Maximum Continuous Body Diode Forward Current (Note 6) | | ls | 80 | A |
| Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%) | | lsм | 320 | A |
| Avalanche Current, L = 0.1mH | | las | 20 | A |
| Avalanche Energy, L = 0.1mH | | Eas | 20 | mJ |

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. 6. Thermal resistance from junction to soldering point (on the exposed drain pad).



Thermal Characteristics

| Characteristic | | Symbol | Value | Unit |
|---|------------------------|------------------|-------------|------|
| Total Power Dissipation (Note 5) | T _A = +25°C | PD | 2.9 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | | Reja | 52 | °C/W |
| Total Power Dissipation (Note 6) T _C = +25°C | | PD | 75 | W |
| Thermal Resistance, Junction to Case (Note 6) | | R _{θJC} | 2.0 | °C/W |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to +175 | °C |

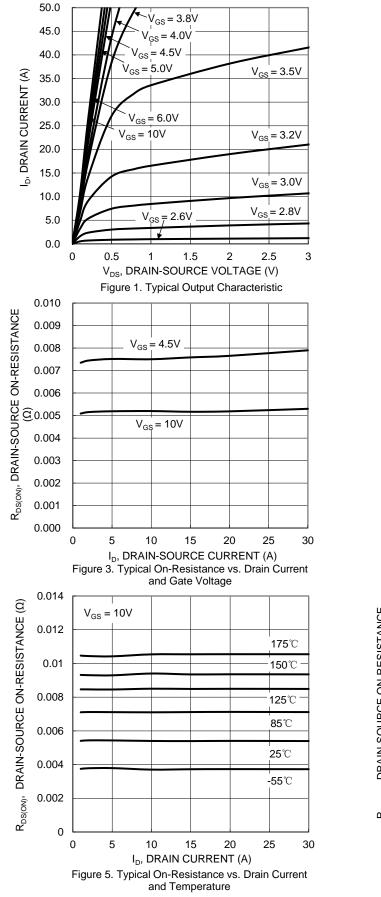
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

| | | | _ | | | |
|--|---------------------|-----|-------|------|------|--|
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
| OFF CHARACTERISTICS (Note 7) | | | | 1 | 1 | |
| Drain-Source Breakdown Voltage | BVDSS | 60 | — | — | V | $V_{GS} = 0V, I_D = 1mA$ |
| Zero Gate Voltage Drain Current | IDSS | _ | — | 1 | μA | $V_{DS} = 48V, V_{GS} = 0V$ |
| Gate-Source Leakage | Igss | _ | — | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 7) | | | | | | |
| Gate Threshold Voltage | VGS(TH) | 1 | — | 3 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ |
| Static Drain-Source On-Resistance | Deserver | _ | 5.3 | 8 | mΩ | VGS = 10V, ID = 20A |
| Static Drain-Source On-Resistance | Rds(on) | _ | 7.9 | 12 | 1112 | Vgs = 4.5V, ID = 20A |
| Diode Forward Voltage | Vsd | _ | 0.8 | 1.2 | V | VGS = 0V, IS = 20A |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | |
| Input Capacitance | Ciss | — | 2,090 | _ | | V _{DS} = 30V, V _{GS} = 0V, f = 1MHz |
| Output Capacitance | Coss | _ | 746 | _ | pF | |
| Reverse Transfer Capacitance | Crss | _ | 38.5 | | | |
| Gate Resistance | Rg | _ | 0.59 | _ | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$ |
| Total Gate Charge (V _{GS} = 4.5V) | Qg | _ | 19.3 | | | |
| Total Gate Charge (V _{GS} = 10V) | Qg | _ | 41.3 | _ | nC | V _{DS} = 30V, I _D = 20A |
| Gate-Source Charge | Qgs | _ | 6 | _ | nc | |
| Gate-Drain Charge | Q _{gd} | — | 8.8 | _ | | |
| Turn-On Delay Time | tD(ON) | _ | 5.7 | _ | | |
| Turn-On Rise Time | tR | | 4.3 | | | V _{DD} = 30V, V _{GS} = 10V, |
| Turn-Off Delay Time | t _{D(OFF)} | | 23.4 | — | ns | $I_D = 20A, R_g = 3\Omega$ |
| Turn-Off Fall Time | tF | _ | 9.7 | _ | | |
| Body Diode Reverse Recovery Time | trr | _ | 35.4 | | ns | $I_{\rm T} = 200$ di/dt = 1000///:2 |
| Body Diode Reverse Recovery Charge | Q _{RR} | _ | 38.2 | _ | nC | I _F = 20A, di/dt = 100A/μs |

 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad).
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:



DMTH6010LPSW



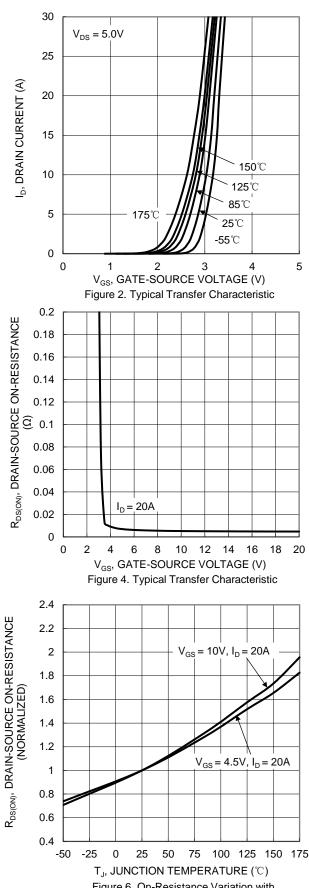
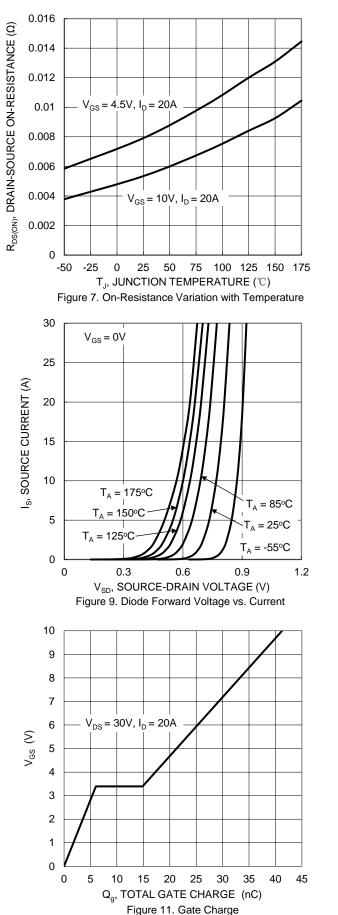
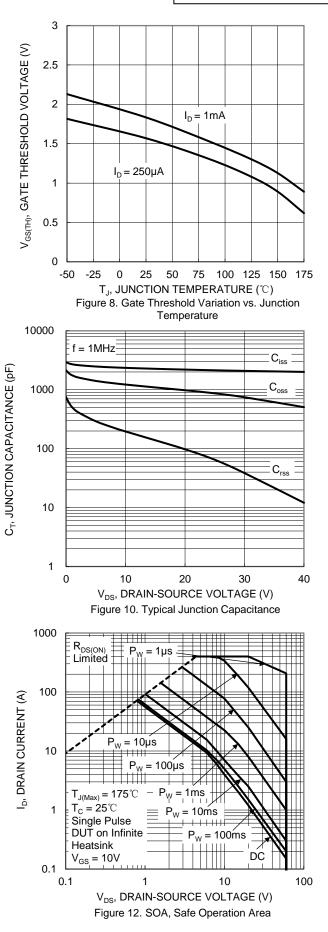


Figure 6. On-Resistance Variation with Temperature



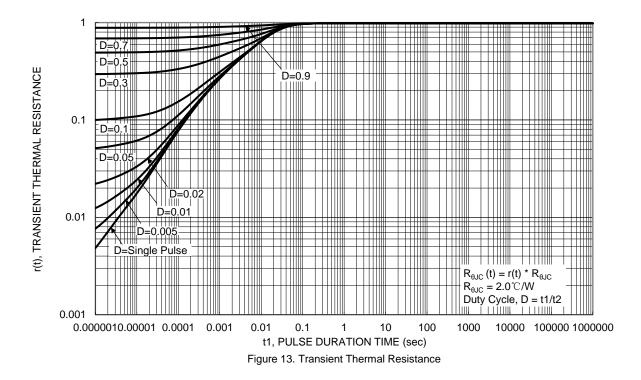






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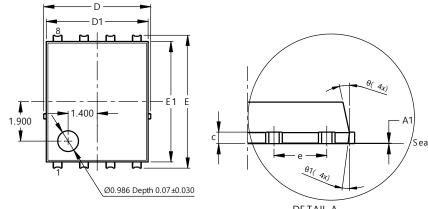




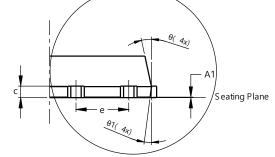


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

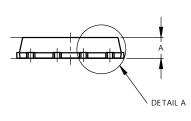


| b(8x) | $ \begin{array}{c} - \\ - \\ - \\ - \\ - \\ - \\ - \\ - \\ - \\ - $ |
|---|---|
| E2a La La La La La La | |



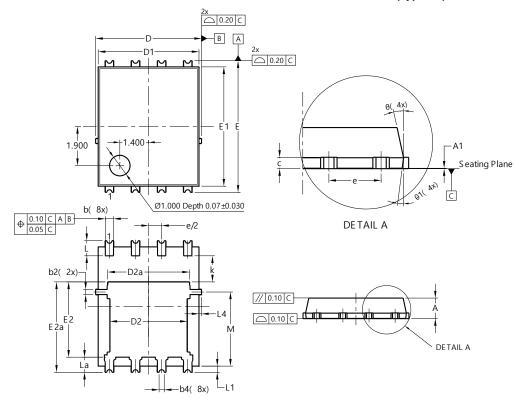
PowerDI5060-8 (SWP) (Type Q)

DETAIL A



| PowerDI5060-8 (SWP) | | | | | |
|----------------------|-------------|----------------|-------|--|--|
| | (Type Q) | | | | |
| Dim | Min Max Typ | | | | |
| Α | 0.90 | 1.10 | 1.00 | | |
| A1 | 0 | 0.05 | - | | |
| b | 0.30 | 0.50 | 0.41 | | |
| b2 | 0.20 | 0.35 | 0.25 | | |
| b4 | 0 |).25REF | - | | |
| c | 0.230 | 0.330 | 0.277 | | |
| D | 5 | .15 BS0 | 2 | | |
| D1 | 4.70 | 5.10 | 4.90 | | |
| D2 | 3.56 | 3.56 3.96 3.76 | | | |
| D2a | 3.78 | 4.18 | 3.98 | | |
| Е | 6.40 BSC | | | | |
| E1 | 5.60 | 6.00 | 5.80 | | |
| E2 | 3.46 | 3.86 | 3.66 | | |
| E2a | 4.195 | 4.595 | 4.395 | | |
| е | 1 | .27BSC |) | | |
| k | 1.05 | | | | |
| L | 0.635 | 0.835 | 0.735 | | |
| La | 0.635 | 0.835 | 0.735 | | |
| L1 | 0.200 | 0.400 | 0.300 | | |
| L1a | 0 | .050RE | F | | |
| L4 | 0.025 | 0.225 | 0.125 | | |
| Μ | 3.205 | 4.005 | 3.605 | | |
| θ | 10° | 12° | 11° | | |
| θ1 | 6° | 8° | 7° | | |
| All Dimensions in mm | | | | | |

PowerDI5060-8/SWP (Type UX)



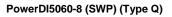
| Po | PowerDI5060-8/SWP (Type UX) | | | |
|----------------------|--------------------------------|----------|-------|--|
| Dim | Min Max Typ | | | |
| Α | 0.90 | 1.10 | 1.00 | |
| A1 | 0 | 0.05 | | |
| b | 0.30 | 0.50 | 0.41 | |
| b2 | 0.20 | 0.35 | 0.25 | |
| b4 | (|).25REF | - | |
| c | 0.230 | 0.330 | 0.277 | |
| D | 5 | 5.15 BSC | | |
| D1 | 4.70 | 5.10 | 4.90 | |
| D2 | 3.56 | 3.96 | 3.76 | |
| D2a | 3.78 | 4.18 | 3.98 | |
| ш | 6 | 6.40 BSC | | |
| E1 | 5.60 6.00 | | 5.80 | |
| E2 | 3.46 | 3.86 | 3.66 | |
| E2a | 4.195 | 4.595 | 4.395 | |
| e | 1 | .27BSC |) | |
| k | 1.05 | | | |
| L | 0.635 | 0.835 | 0.735 | |
| La | 0.635 | 0.835 | 0.735 | |
| L1 | 0.200 | 0.400 | 0.300 | |
| L4 | 0.025 | 0.225 | 0.125 | |
| Μ | 3.205 | 4.005 | 3.605 | |
| θ | 10° | 12° | 11° | |
| θ1 | 6° | 8° | 7° | |
| All Dimensions in mm | | | | |

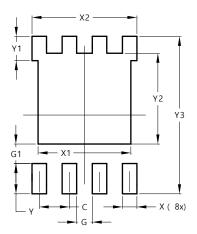
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Suggested Pad Layout

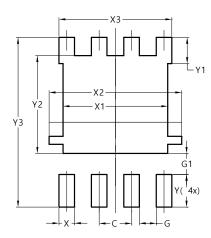
Please see http://www.diodes.com/package-outlines.html for the latest version.





| Dimensions | Value |
|------------|---------|
| | (in mm) |
| C | 1.270 |
| G | 0.660 |
| G1 | 0.820 |
| Х | 0.610 |
| X1 | 4.100 |
| X2 | 4.420 |
| Y | 1.270 |
| Y1 | 1.020 |
| Y2 | 3.810 |
| Y3 | 6.610 |

PowerDI5060-8/SWP (Type UX)



| Dimensions | Value (in mm) | | |
|------------|------------------|--|--|
| С | 1.270 | | |
| G | 0.660 | | |
| G1 | 0.820 | | |
| Х | 0.610 | | |
| X1 | 4.100 | | |
| X2 | 5.190 | | |
| X3 | 4.420 | | |
| Y | 1.270 | | |
| Y1 | 1.020 | | |
| Y2 | 3.810 | | |
| Y3 | 6.610 | | |



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